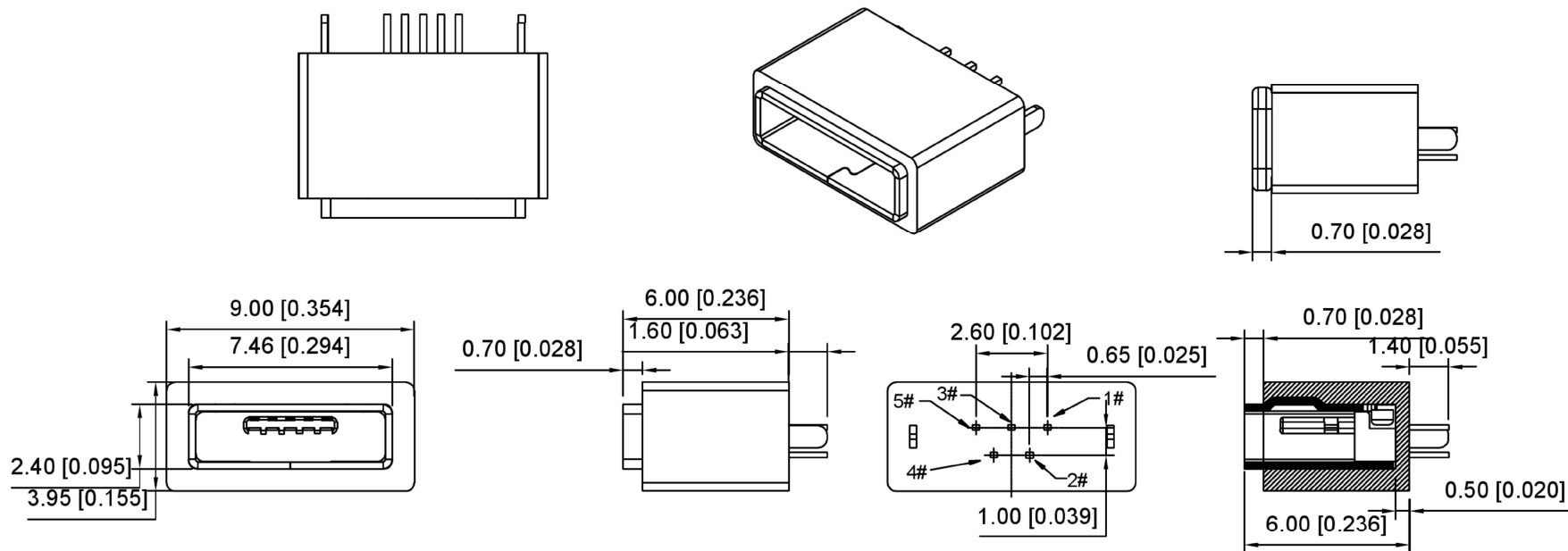




1.Material:

1.1 Housing: High temperature thermoplastic with g.f,UL94v-0

1.2 Contact: copper alloy, $t=0.20\text{mm}$

1.3 Shell: copper alloy, $t=0.25\text{mm}$

2.Specification:

2.1 Current rating: 1A Max

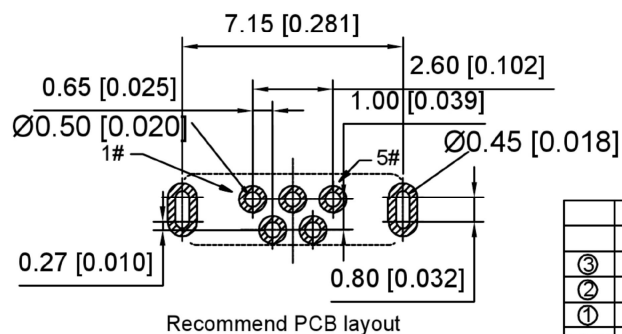
2.2 Dielectric withstanding voltage: 100V(AC) for 1 min.

2.3 Contact resistance: $50\text{m}\Omega$ Max.

2.4 Insulation resistance: $100\text{m}\Omega$ min.

2.5 Total mating force: 3.57 Kgf Max.

2.6 Total unmating force: 1.0 Kgf Min.
0.81~2.05 Kgf Min.
after 10,000 insertion/extraction cycles



ITEM	PART NAME	QTY	MATERIAL	FINISHING
③	Shell	1	SUS304R-1/2H	Ni Plating T=0.3mm (3u)
②	Terminal	5	Phosphor Bronze C5191R-EH	Au/Ni Plating T=0.2mm (1u)
①	Housing	1	HI-TEMP PLASIC UL 94V-0	BLACK

				ANGLAR	±5°
				L ≤ 4	±0.2
				4<L ≤ 16	±0.3
				16<L ≤ 63	±0.4
				L> 63	±0.5
REVISIONS				UNSPECIFIED TOLERANCES	
www.alpsr.com www.gdxjdz.com www.xbswitch.com					



DONG GUAN XI BANG ELECTRONIC CO., LTD

DSND		SCALE: N/A	MODEL TYPE: MICRO USB
DWN		VIEW:	PART NO.:
CHKD		UNIT: mm/in	DWG NO.:
APPD		SIZE: A4	U-E-M5SS-W-0
		WEIGHT	SHEET
			1/1
		REVISION	A0